Amendments to the Specification

Rewrite the replacement paragraph on page 14 at lines 8-19 as follows:

Similar to the transmission area of the duplexer dielectric filter as shown in Fig. 3, when two resonators R1, R2 are formed between the ground electrodes in the same manner as expected from a conventional duplexer dielectric filter as shown in Fig. 5A, a loading capacitance Ct1, Ct2 (Ct1 is a random value) is formed between the resonators R1, R2 and the ground electrodes. In addition, a coupling capacitance Ct12 (Ct12 is a random value) is formed between the resonators R1, R2. On the other hand, similar to the reception area of the duplexer dielectric filter as shown in Fig. 3, when the ground electrode is partially open as expected from the present invention as shown in Fig. 5B, a loading capacitance Cr3, Cr4 Ct3, Ct4 is formed between the resonators R3, R4 and the ground electrodes. In addition, a coupling capacitance Cr34 Ct34 is formed between the resonators R3, R4.

Rewrite the replacement paragraph spanning pages 17 and 18 as follows:

Fig. 6A is a perspective view showing the construction of a duplexer dielectric filter in accordance with the fourth embodiment of the present invention. Fig. 6B is an equivalent circuit diagram of the duplexer dielectric filter of Fig. 6A. In the fourth embodiment, the general shape of the duplexer dielectric filter remains the same as that described for the primary embodiment of Fig. 3, but the structure of the open area 325 is altered (see Fig. 6A). Referring to Fig 6A, the duplexer dielectric filter according to the fourth embodiment comprises the dielectric block 401 having an upper surface 403, a lower surface, and a side surface 405. A series of resonating holes 407 are formed in the dielectric block 401. The resonating holes 407 are coated with a conductive material on at least a part of their internal surfaces to form resonators. At least one conductive pattern 409 is formed on the upper surface 403 at a position around each of the resonating holes 407. The transmission and the reception terminals and an antenna terminal 412c, 412a and 412b. are disposed on upper and side surfaces 403 and 405 of the dielectric block 401, and are insulated from the conductive material disposed on the side surface 405 of the dielectric block by open areas 414a,

414b and 414c, respectively. While the three resonating holes 407, formed in the dielectric block 401 at the left-hand side of the antenna terminal 412c, are included within the transmission area 410, another three resonating holes 407 at the right-hand side of the antenna terminal 412c, are included within the reception are 420.